

# Cell Balancing Using the bq20zxx

Yevgen Barsukov

PMP Portable Power

## ABSTRACT

This application report discusses three types of cell imbalances that are observed in a battery pack with serially connected cells.

## 1 Types of Cell Imbalances

### 1. State of Charge Imbalance

Charging cells to different states of charge (SOC) causes this type of imbalance. For example, given a configuration of 3 x 2200-mAh cells (Q<sub>Max</sub>), if one cell is discharged by 100 mAh (Q<sub>1</sub>), the second by 100 mAh, and the third by 200 mAh from a fully charged state, the first and second cells' chemical state of charge is  $(Q_{max}-Q_1)/Q_{max} = 95.4\%$ , but the third cell is 91%. Therefore, cell 3 is imbalanced by 4.4%.

This results in a different open-circuit voltage (OCV) for cell 3 compared to cells 1 and 2, because the OCV directly correlates with the chemical state of charge.

### 2. Total Cell Capacity Imbalance

A specific cell's total chemical capacity, Q<sub>max</sub>, initially may be different from the others in the cell package. So, even if all cells were discharged by an equal amount from a fully charged state, their chemical states of charge may be different. Indeed, if all 3 cells are discharged by 100 mAh, but cell 3 has different total capacity (e.g., 2000 mAh), the resulting chemical states of charge is 95.4% and 95%.

This results in different OCVs. A 200-mAh difference in Q<sub>max</sub> causes only a 0.4% difference in SOC because the SOC correlates with voltage. This indicates that the capacity imbalance causes less voltage difference than charge imbalance (cause 1).

### 3. Impedance Imbalance

Internal impedance differences between the cells (that can be an approximate 15% range in the same production batch) do not cause differences in the OCV. However, they can cause differences in cell voltage during discharge. Indeed, cell voltage can be approximated as  $V = OCV + I \times R$ . If current is negative (discharge), voltage is lower for a cell with higher R. If current is positive (charge), voltage is higher for a cell with higher R.

No balancing algorithm can help against resistance imbalance. However, it can significantly distort attempts to balance the SOC. If significant (< 200 mA) current is flowing, attempting to use voltage as a determining factor for passing more charge through a cell with higher voltage, fails to determine if the voltage differences is caused by differences in the SOC or by impedance. If it is caused by impedance imbalance, bypassing more current through this cell results in the opposite effect – increasing the SOC difference from other cells to a larger value than it would be without balancing. As a result, the OCV of this cell at the end of charge is different from the other cells, and can reach high levels, potentially causing the safety circuit to trip.

## 2 Cell Balancing Methods

The bq20zxx uses the unique capabilities of Impedance Track™ technology to identify the chemical SOC of each cell, which does not rely on measuring voltage during charge or discharge. This removes the distortion caused by impedance imbalance, and permits precise SOC balancing. The cell-balancing algorithm operates as follows:

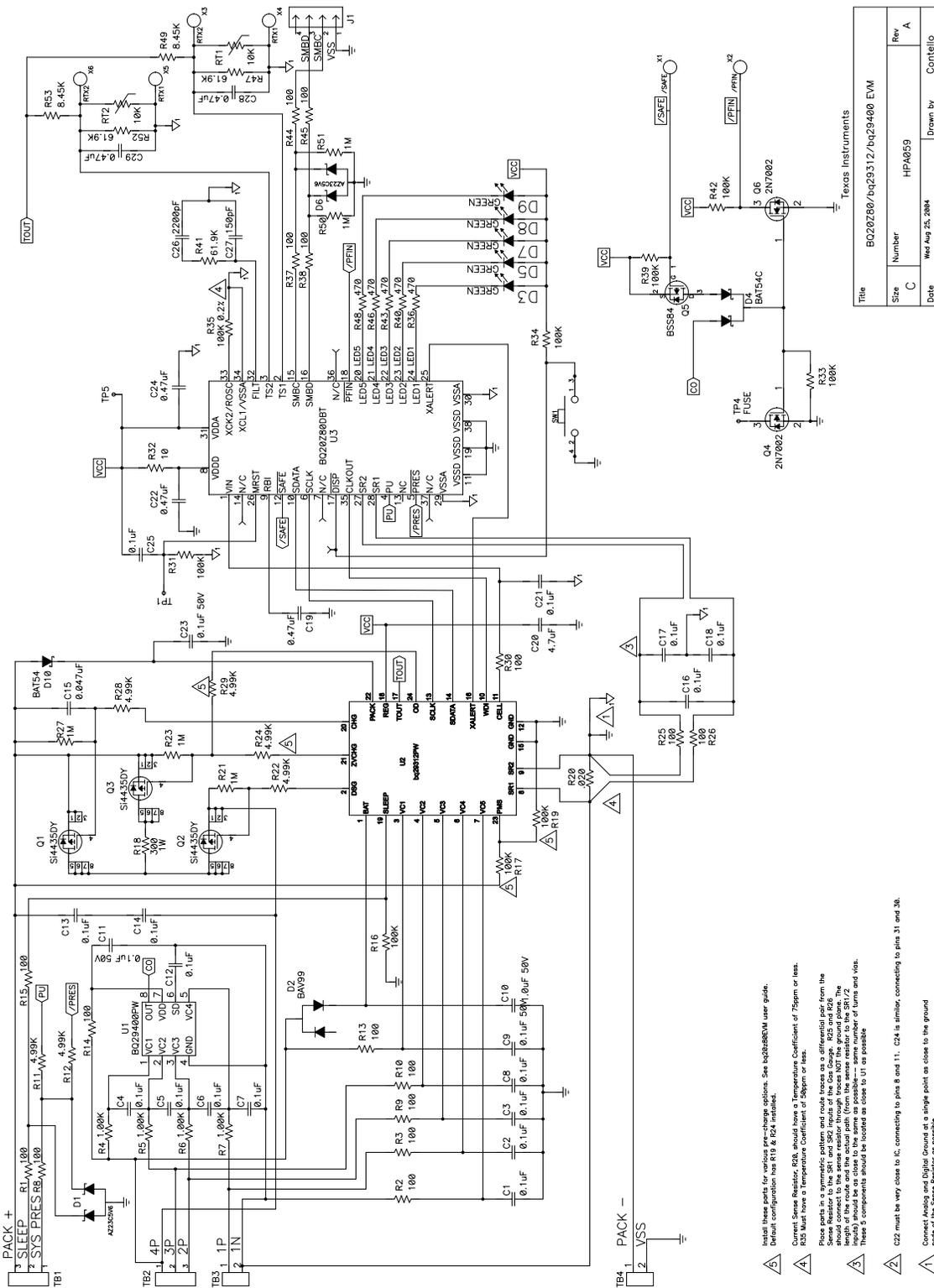
- (a) Determine the initial SOC for each series cell bank separately.
- (b) Determine the charge needed for each cell to reach a fully charged state.

Impedance Track is a trademark of Texas Instruments.

- (c) Find the cell requiring the most charge to be fully charged, and then find the differences,  $dQ$ , between all the other cells requiring charge and that of the one requiring the most charge.
- (d) These differences must be bypassed for each “excessive” cell during one or multiple cycles. To achieve this, the bypass FET is turned ON during charging for the calculated duration for each cell bypass time.
- (e) The bypass time is calculated based on the value of bypass current, which in turn depends on bypass resistance values,  $R$ , as  $\text{time} = dQ \times R / (V \times \text{duty\_cycle})$ .
- (f)  $R$  is calculated as the sum of the internal bypass resistor (340  $\Omega$ , typical) and the series filter resistors ( $R_x$ ) leading to the cells.  $R = R_x \times 2 + 340$ . The resistors in question are R2, R3, R9, and R10. Their default value is 100  $\Omega$ , which results in  $R = 540$ .
- (g) The bq20zxx stores the value of  $R(\Omega) \times 3.6 / (V \times \text{duty\_cycle (ratio)})$  as a flash constant DF.MinCellDeviation (s/mAh). Here, 3.6 is the mAh correction factor. For default values of voltage,  $V = 3.6$  V,  $R = 540$   $\Omega$  and duty cycle = 40% (ratio 0.4), the value is calculated as  
$$\text{DF.MinCellDeviation} = 540 \times 3.6 / (3.6 \times 0.4) = 1350$$

This value must be changed if values of resistors R2, R3, R9, and R10 are changed from the default value.

The schematic appears on the following page.



SCHMATIC

- ⑤ Indicate sense paths for voltage sense chips. See bq20zxx user guide.
- ⑥ Current Sense Resistor, R24, should have a Temperature Coefficient of 75ppm or less.
- ⑦ C22 must be very close to IC, connecting to pins 8 and 11. C24 is similar, connecting to pins 31 and 30.
- ⑧ Connect Analog and Digital Current at a single point as close to the ground node of the Sense Resistor as possible.

Title	BQ20Z80/bq20zxx/bq20zxx EVM		
Size	Number	Rev	A
C	HPA059		
Date	Wed Aug 25, 2004	Drawn by	Contello

## IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

### Products

Audio	<a href="http://www.ti.com/audio">www.ti.com/audio</a>
Amplifiers	<a href="http://amplifier.ti.com">amplifier.ti.com</a>
Data Converters	<a href="http://dataconverter.ti.com">dataconverter.ti.com</a>
DLP® Products	<a href="http://www.dlp.com">www.dlp.com</a>
DSP	<a href="http://dsp.ti.com">dsp.ti.com</a>
Clocks and Timers	<a href="http://www.ti.com/clocks">www.ti.com/clocks</a>
Interface	<a href="http://interface.ti.com">interface.ti.com</a>
Logic	<a href="http://logic.ti.com">logic.ti.com</a>
Power Mgmt	<a href="http://power.ti.com">power.ti.com</a>
Microcontrollers	<a href="http://microcontroller.ti.com">microcontroller.ti.com</a>
RFID	<a href="http://www.ti-rfid.com">www.ti-rfid.com</a>
RF/IF and ZigBee® Solutions	<a href="http://www.ti.com/lprf">www.ti.com/lprf</a>

### Applications

Communications and Telecom	<a href="http://www.ti.com/communications">www.ti.com/communications</a>
Computers and Peripherals	<a href="http://www.ti.com/computers">www.ti.com/computers</a>
Consumer Electronics	<a href="http://www.ti.com/consumer-apps">www.ti.com/consumer-apps</a>
Energy and Lighting	<a href="http://www.ti.com/energy">www.ti.com/energy</a>
Industrial	<a href="http://www.ti.com/industrial">www.ti.com/industrial</a>
Medical	<a href="http://www.ti.com/medical">www.ti.com/medical</a>
Security	<a href="http://www.ti.com/security">www.ti.com/security</a>
Space, Avionics and Defense	<a href="http://www.ti.com/space-avionics-defense">www.ti.com/space-avionics-defense</a>
Transportation and Automotive	<a href="http://www.ti.com/automotive">www.ti.com/automotive</a>
Video and Imaging	<a href="http://www.ti.com/video">www.ti.com/video</a>
Wireless	<a href="http://www.ti.com/wireless-apps">www.ti.com/wireless-apps</a>

TI E2E Community Home Page

[e2e.ti.com](http://e2e.ti.com)

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265  
Copyright © 2011, Texas Instruments Incorporated